

**AMENDMENTS TO THE CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Claims:**

Claim 1 (Currently amended): A holder for an electronic module for connection to a printed circuit board in an electronic equipment, the holder being arranged to receive the electronic module and having a portion provided with at least one hole therethrough,

wherein at least one hole is arranged to provide access through the holder to the printed circuit board for testing; and

the holder is further provided with a conductive layer on a surface of the portion with the at least one hole therethrough for positioning adjacent the printed circuitry board.

Claim 2 (Original): The holder of claim 1 wherein the at least one hole is arranged to be covered by the electronic module when positioned in the holder.

Claim 3 (Previously presented): The holder of claim 1 wherein the holder is provided with a plurality of holes therethrough.

Claim 4 (Previously presented): The holder of claim 1 wherein the holder is arranged to be mounted on the printed circuitry board by one of A or B, wherein:

A comprises surface mount technology, and

B comprises plated through hole technology.

Claim 5 (Cancelled)

Claim 6 (Previously presented): The holder of claim 1 wherein the electronic module comprises a subscriber identification module.

Claim 7 (Previously presented): The holder of claim 1 wherein the electronic equipment comprises wireless communication equipment.

Claim 8 (Previously presented): The holder of claim 7 wherein the wireless communication equipment comprises a portable modem.

Claim 9 (Cancelled)

Claim 10 (Previously presented): The holder of claim 1 wherein the holder is of moulded plastics material.

Claim 11 (Currently amended): A method of assembling a holder for an electronic module on a printed circuit board in an electronic equipment, the method comprising:

providing the printed circuit board;

providing a holder for the electronic module for mounting to the printed circuit board, the holder being arranged to receive the electronic module and having a portion provided with at least one hole to provide access through the holder ~~[[of]]~~to the printed circuit board for testing purposes;

providing ~~the holder with~~ a conductive layer on a surface of the portion with the at least one hole for positioning adjacent the printed circuit board; and

mounting the holder on the printed circuit board.

Claim 12 (Previously presented): The method of claim 11 further comprising inserting the electronic module in the holder such that the at least one hole is covered by the electronic module.

Claim 13 (Previously presented): The method of claim 11 wherein the holder is provided with a plurality of holes therethrough.

Claim 14 (Previously presented): The method of claim 11 wherein the step of mounting comprises mounting the electronic module on the printed circuit board by one of A or B, wherein:

A comprises surface mount technology, and

B comprises plated through hole technology.

Claim 15 (Cancelled)

Claim 16 (Previously presented): The method of claim 11 wherein the electronic module comprises a subscriber identification module.

Claim 17 (Previously presented): The method of claim 11 wherein the electronic equipment comprises wireless communication equipment.

Claim 18 (Previously presented): The method of claim 17 wherein the wireless communication equipment comprises a portable modem.

Claim 19 (Cancelled)

Claim 20 (Currently amended): The method of claim 11[[-]], wherein the holder is moulded of plastics material.

Claim 21 (Cancelled)

Claim 22 (Previously presented): An electronic circuit having mounted thereon the holder of claim 1.

Claim 23 (Cancelled)

Claim 24 (Cancelled)